



2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Applicants : Kun-Chih Wang) Examiner: Nguyen, Dilinh P
Serial No. : 09/880,518) Group Art Unit: 2814
Filed : June 12, 2001)
For : Bonding Pad Structure) Attorney Docket: JC-7265-C

CERTIFICATE OF TRANSMISSION VIA FACSIMILE UNDER 37 CFR § 1.6; MPEP 502.01

I hereby certify that this correspondence (RESPONSE UNDER 37 CFR 1.116) is being transmitted via facsimile to:

EXAMINER DILINH P. NGUYEN
USPTO ART UNIT 2814
FACSIMILE NO.: 703-308-7722

on April 7, 2003

Charles C.H. Wu
Charles C.H. Wu

No fee is believed to be due in connection with this amendment and response to Office Action. If, however, any fee is believed to be due, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 500314.

Charles C.H. Wu
Signature

RESPONSE TO FIRST OFFICE ACTION

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

The Office Action mailed January 17, 2003 (Paper No. 9), has been carefully considered. In response thereto, please consider the following remarks.

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